

TEMEXPRESS

TMX W333

Low Loss SAW Bandpass Filter - WIRELESS AUDIO - RF
Specification (Rev-3)

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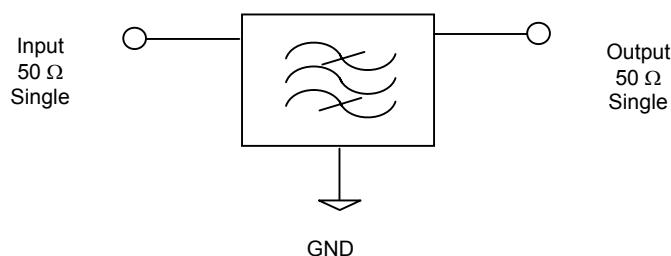
March 08th, 2016

Electrical Parameters	Unit	Minimum	Typical ⁽¹⁾	Maximum
Source Impedance (single ended)	Ω	-	50 ⁽²⁾	-
Load Impedance (single ended)	Ω	-	50 ⁽²⁾	-
Center Frequency f_0	MHz	-	864	-
Absolute Attenuation				
300 MHz to 848 MHz	dB	39	45	-
848 MHz to 853.3 MHz	dB	30	35	-
878 MHz to 882 MHz	dB	35	40	-
882 MHz to 1200 MHz	dB	48	55	-
Insertion Loss in 862.5 MHz-865.5 MHz	dB	-	2.5	3.4
Amplitude Ripple in 862.5 MHz-865.5 MHz	dB	-	0.5	1.5
VSWR	dB	-	-	2.2
Temperature Coefficient of Frequency	ppm/k	-	-30	-
Package type & size				
Length x Width	mm ²	-	3.0 x 3.0	-
Height	mm	-	1.3	1.5
Pin Out				
Input	2	Output	5	
Case Ground	1, 3, 4, 6	To Be Grounded	1, 3, 4, 6	

Notes :

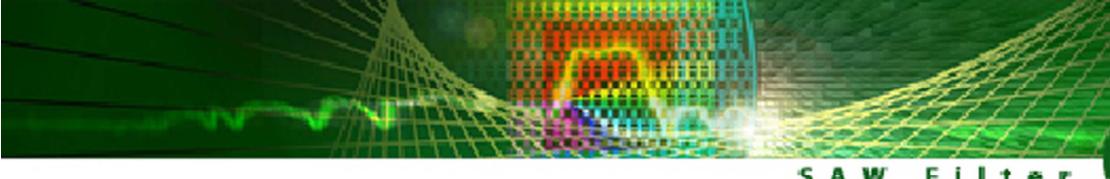
- (1) Typical values are nominal performances at room temperature
- (2) No external matching circuit is required

50 Ω / 50 Ω CONFIGURATION



Maximum Ratings

Rating	Unit	Value
Operating Temperature Range	°C	-40 to +80
Storage Temperature Range	°C	-40 to +85
DC Permissive Voltage	V	10
Maximum RF Power	dBm	10



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SAW Filter

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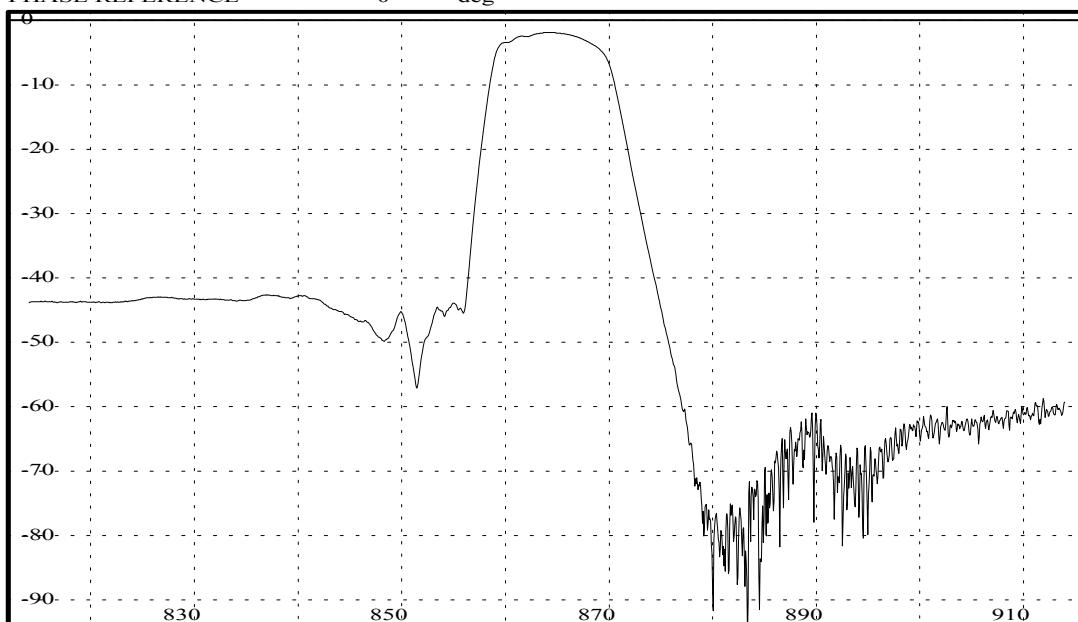
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TYPICAL S21 RESPONSE

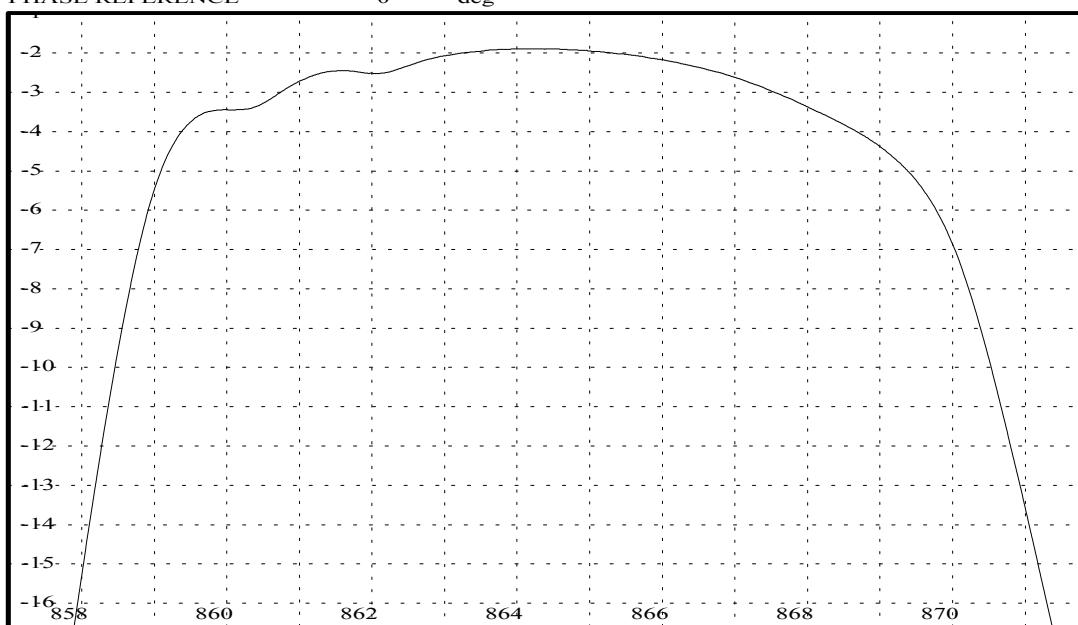
References

	= 0	MHz	SCALE_FREQUENCY	= 10	MHz/div
CENTER FREQUENCY	= 0	MHz	SCALE_FREQUENCY	= 10	MHz/div
LOSS REFERENCE	= 0	dB			
DELAY REFERENCE	= 0	μs			
PHASE REFERENCE	= 0	deg			



References

	= 0	MHz	SCALE_FREQUENCY	= 1	MHz/div
CENTER FREQUENCY	= 0	MHz	SCALE_FREQUENCY	= 1	MHz/div
LOSS REFERENCE	= 0	dB			
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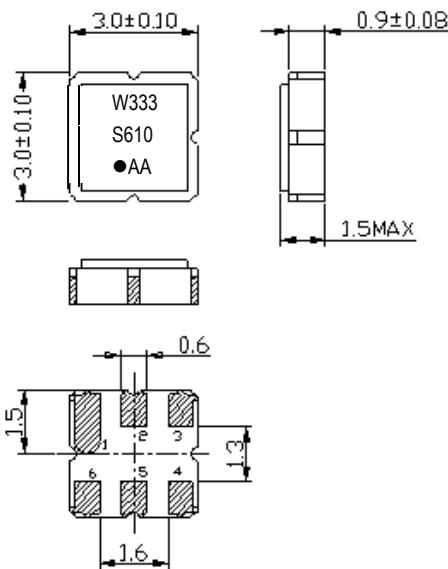
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PACKAGE DRAWING

Unit: mm



Pin configuration	
2	Input
5	Output
1,3,4,6	Ground

Marking		
Line 1	W333	Temexpress designation
Line 2	S609	S is production Code / 6 is Year 2016 & 09 is Week 09
Line 3	AA	AA" is internal production batch code, it corresponds to the wafer

Marking is made by Laser